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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10018559	12/25/2001	154		1722	

****APPLICANTS:** Karieto Kinkawa, Hiroshi Mitsu, Masahiro Nakata

****CONTINUING DATA VERIFIED:**
THIS APPLICATION IS A 371 OF PCT/JP01/01292 (4/17/2001)

**** FOREIGN APPLICATIONS VERIFIED:**
JAPAN 2000-120567 04/21/2000
JAPAN 2000-148123 05/19/2000
JAPAN 2000-171684 06/08/2000

PG-PUB ☐ DO NOT PUBLISH ☐ RESCIND ☐

Foreign priority claimed ☐ - yes ☐ - no
35 USC 119 conditions met ☐ - yes ☐ - no
Verified and Acknowledged Examiner's initials

ATTORNEY DOCKET NO.
04632 0340

TITLE : Die molding machine and pattern carrier

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
		DRAWING	
		Sheets Drwg.	Figs Drwg.
		Print Fig.	
ISSUE FEE			
Amount Due	Date Paid		
		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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